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DS1230Y/AB 256k Nonvolatile SRAM

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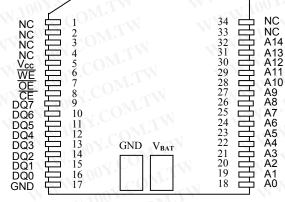
FEATURES

- 10 years minimum data retention in the absence of external power
- Data is automatically protected during power loss
- Replaces 32k x 8 volatile static RAM, EEPROM or Flash memory
- Unlimited write cycles
- Low-power CMOS
- Read and write access times as fast as 70 ns
- Lithium energy source is electrically disconnected to retain freshness until power is applied for the first time
- Full ±10% V_{CC} operating range (DS1230Y)
- Optional ±5% V_{CC} operating range (DS1230AB)
- Optional industrial temperature range of -40°C to +85°C, designated IND
- JEDEC standard 28-pin DIP package
- PowerCap Module (PCM) package
 - Directly surface-mountable module
 - Replaceable snap-on PowerCap provides lithium backup battery
 - Standardized pinout for all nonvolatile SRAM products
 - Detachment feature on PowerCap allows easy removal using a regular screwdriver

PIN ASSIGNMENT

A14	1	28	Vcc
A12	2	27	WE
A7	3	26	A13
A6	4	25	A8
A5	5	24	A9
A4	6	23	A11
A3	■ 7	22	OE
A2	8	21	<u>A10</u>
A1	9	20	CE
A0	10	19	DQ7
DQ0	11	18	DQ6
DQ1	12	17	DQ5
DQ2	13	16	DQ3
GND	14	15	DQ4 DQ3

28-Pin ENCAPSULATED PACKAGE 740-mil EXTENDED



34-Pin POWERCAP MODULE (PCM) (USES DS9034PC POWERCAP)

PIN DESCRIPTION

A0 - A14	- Address Inputs
DQ0 - DQ7	- Data In/Data Out
CE	- Chip Enable
WE	- Write Enable
ŌĒ	- Output Enable
V _{CC}	- Power (+5V)
GND	- Ground
NC	- No Connect

DESCRIPTION

The DS1230 256k Nonvolatile SRAMs are 262,144-bit, fully static, nonvolatile SRAMs organized as 32,768 words by 8 bits. Each NV SRAM has a self-contained lithium energy source and control circuitry which constantly monitors V_{CC} for an out-of-tolerance condition. When such a condition occurs, the lithium energy source is automatically switched on and write protection is unconditionally enabled to prevent data corruption. DIP-package DS1230 devices can be used in place of existing 32k x 8 static RAMs directly conforming to the popular bytewide 28-pin DIP standard. The DIP devices also match the pinout of 28256 EEPROMs, allowing direct substitution while enhancing performance. DS1230 devices in the Low Profile Module package are specifically designed for surface-mount applications. There is no limit on the number of write cycles that can be executed and no additional support circuitry is required for microprocessor interfacing.

READ MODE

The DS1230 devices execute a read cycle whenever \overline{WE} (Write Enable) is inactive (high) and \overline{CE} (Chip Enable) and \overline{OE} (Output Enable) are active (low). The unique address specified by the 15 address inputs (A₀ - A₁₄) defines which of the 32,768 bytes of data is to be accessed. Valid data will be available to the eight data output drivers within t_{ACC} (Access Time) after the last address input signal is stable, providing that \overline{CE} and \overline{OE} (Output Enable) access times are also satisfied. If \overline{OE} and \overline{CE} access times are not satisfied, then data access must be measured from the later-occurring signal (\overline{CE} or \overline{OE}) and the limiting parameter is either t_{CO} for \overline{CE} or t_{OE} for \overline{OE} rather than address access.

WRITE MODE

The DS1230 devices execute a write cycle whenever the \overline{WE} and \overline{CE} signals are active (low) after address inputs are stable. The later-occurring falling edge of \overline{CE} or \overline{WE} will determine the start of the write cycle. The write cycle is terminated by the earlier rising edge of \overline{CE} or \overline{WE} . All address inputs must be kept valid throughout the write cycle. \overline{WE} must return to the high state for a minimum recovery time (t_{WR}) before another cycle can be initiated. The \overline{OE} control signal should be kept inactive (high) during write cycles to avoid bus contention. However, if the output drivers are enabled (\overline{CE} and \overline{OE} active) then \overline{WE} will disable the outputs in t_{ODW} from its falling edge.

DATA RETENTION MODE

The DS1230AB provides full functional capability for V_{CC} greater than 4.75 volts and write protects by 4.5 volts. The DS1230Y provides full functional capability for V_{CC} greater than 4.5 volts and write protects by 4.25 volts. Data is maintained in the absence of V_{CC} without any additional support circuitry. The nonvolatile static RAMs constantly monitor V_{CC} . Should the supply voltage decay, the NV SRAMs automatically write protect themselves, all inputs become "don't care," and all outputs become high-impedance. As V_{CC} falls below approximately 3.0 volts, a power switching circuit connects the lithium energy source to RAM to retain data. During power-up, when V_{CC} rises above approximately 3.0 volts the power switching circuit connects external V_{CC} to RAM and disconnects the lithium energy source. Normal RAM operation can resume after V_{CC} exceeds 4.75 volts for the DS1230AB and 4.5 volts for the DS1230Y.

FRESHNESS SEAL

Each DS1230 device is shipped from Dallas Semiconductor with its lithium energy source disconnected, guaranteeing full energy capacity. When V_{CC} is first applied at a level greater than 4.25 volts, the lithium energy source is enabled for battery back-up operation.

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PACKAGES

The DS1230 devices are available in two packages: 28-pin DIP and 34-pin PowerCap Module (PCM). The 28-pin DIP integrates a lithium battery, an SRAM memory and a nonvolatile control function into a single package with a JEDEC-standard, 600-mil DIP pinout. The 34-pin PowerCap Module integrates SRAM memory and nonvolatile control along with contacts for connection to the lithium battery in the DS9034PC PowerCap. The PowerCap Module package design allows a DS1230 PCM device to be surface mounted without subjecting its lithium backup battery to destructive high-temperature reflow soldering. After a DS1230 PCM is reflow soldered, a DS9034PC PowerCap is snapped on top of the PCM to form a complete Nonvolatile SRAM module. The DS9034PC is keyed to prevent improper attachment. DS1230 PowerCap Modules and DS9034PC PowerCaps are ordered separately and shipped in separate containers. See the DS9034PC data sheet for further information.

ABSOLUTE MAXIMUM RATINGS*

Voltage on Any Pin Relative to Ground Operating Temperature Storage Temperature Soldering Temperature -0.3V to +7.0V 0°C to 70°C, -40°C to +85°C for IND parts -40°C to +70°C, -40°C to +85°C for IND parts 260°C for 10 seconds

* This is a stress rating only and functional operation of the device at these or any other conditions above those indicated in the operation sections of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods of time may affect reliability.

RECOMMENDED DC OPERATING CONDITIONS						
SYMBOL	MIN	ТҮР	MAX	UNITS	NOTES	
V _{CC}	4.75	5.0	5.25	V	1001.	
V _{CC}	4.5	5.0	5.5	V	N.1001.	
V _{IH}	2.2	07.00	V _{CC}	V	W.100 r.	
V _{IL}	0.0	001.	0.8	V	W.1001	
	SYMBOLV _{CC} V _{CC} V _{IH}	$\begin{tabular}{ c c c c } \hline SYMBOL & MIN \\ \hline V_{CC} & 4.75 \\ \hline V_{CC} & 4.5 \\ \hline V_{IH} & 2.2 \\ \hline \end{tabular}$	$\begin{array}{ c c c c c } \textbf{SYMBOL} & \textbf{MIN} & \textbf{TYP} \\ \hline V_{CC} & 4.75 & 5.0 \\ \hline V_{CC} & 4.5 & 5.0 \\ \hline V_{IH} & 2.2 \\ \hline \end{array}$	SYMBOL MIN TYP MAX V _{CC} 4.75 5.0 5.25 V _{CC} 4.5 5.0 5.5 V _{IH} 2.2 V _{CC}	SYMBOL MIN TYP MAX UNITS V_{CC} 4.75 5.0 5.25 V V_{CC} 4.5 5.0 5.5 V V_{IH} 2.2 V_{CC} V	

DC ELECTRICAL CHARACTERISTICS	(t _A : See I	Note 10	• 5.31			1230AB) S1230Y)
PARAMETER	SYMBOL	MIN	TYP	MAX	UNITS	NOTES
Input Leakage Current	IIL	-1.0	WW.10	+1.0	μA	WWW
I/O Leakage Current $\overline{CE} \ge V_{IH} \le V_{CC}$	I _{IO}	-1.0	I.WW.I	+1.0	μΑ	
Output Current @ 2.4V	I _{OH}	-1.0	WW.	100 r. CO	mA	
Output Current @ 0.4V	I _{OL}	2.0	WWW	100	mA	
Standby Current $\overline{CE} = 2.2V$	I _{CCS1}		200	600	μA	
Standby Current $\overline{CE} = V_{CC} - 0.5V$	I _{CCS2}		50	150	μΑ	
Operating Current	I _{CCO1}			85	mA	
Write Protection Voltage (DS1230AB)	V _{TP}	4.50	4.62	4.75	V	
Write Protection Voltage (DS1230Y)	V _{TP}	4.25	4.37	4.5	V	

CAPACITANCE	胜	特力材料 特力电子(上海) 特力电子(深圳) Http://www.1	36-21-541 36-755-83	51736 298787	COM.TV COM.TV		0S1230Y/AB ₄=25°C)
PARAMETER	1.9	SYMBOL	MIN	ТҮР	MAX	UNITS	NOTES
Input Capacitance	N	C _{IN}		5	10	pF	
Input/Output Capacitance		CI/O		5	10	pF	

AC ELECTRICAL CHARACTERISTICS

 $(V_{CC}=5V \pm 5\% \text{ for DS1230AB})$ $(t_{A}: See Note 10) (V_{cc}=5V + 10\% \text{ for } DS1230Y)$

PARAMETER	SYMBOL		0AB-70 30Y-70		0AB-85 30Y-85		0AB-100 30Y-100	UNITS	NOTES
	OMITW	MIN	MAX	MIN	MAX	MIN	MAX	Y.COM	TW
Read Cycle Time	t _{RC}	70	NWW.1	85	M.TW	100	WWW.I	ns	N.T.W
Access Time	t _{ACC}		70	1007.0	85		100	ns	M.TW
$\overline{\text{OE}}$ to Output Valid	t _{OE}	N N	35	N.100X	45	LM	50	ns	OM.TW
\overline{CE} to Output Valid	t _{CO}	TW.	70	N.N.100	85	WT.	100	ns	COM.T
\overline{OE} or \overline{CE} to Output Active	t _{COE}	5	V	5	ooy.CO	5	7	ns	5
Output High Z from Deselection	t _{OD}	OM.T	25	MM	30	COM.T	35	ns	5
Output Hold from Address Change	t _{OH}	5 M	TW TW	5	WW.100	5	NT.N WT.M	ns	N.1002
Write Cycle Time	t _{wc}	70	M.TW	85	MMM.	100	OM.TW	ns	WW.100
Write Pulse Width	t _{WP}	55	COM.T	65	WWW	75	COM.T	ns ·	3
Address Setup Time	t _{AW}	0	R.COM.	0	WV WV	0	Y.COM.	ns	WWW
Write Recovery Time	t _{WR1} t _{WR2}	5 15	ov.col	5 15	4 7	5 15	07.CON	ns	12 13
Output High Z from \overline{WE}	t _{ODW}	NWW.	25	OM.TW	30	MMM	35	ns	5
Output Active from \overline{WE}	t _{OEW}	5	N.100Y.	5	W	5		ns	5
Data Setup Time	t _{DS}	30	W.10	35		40		ns	4
Data Hold Time	t _{DH1} t _{DH2}	0 10		0 10		0 10		ns	12 13

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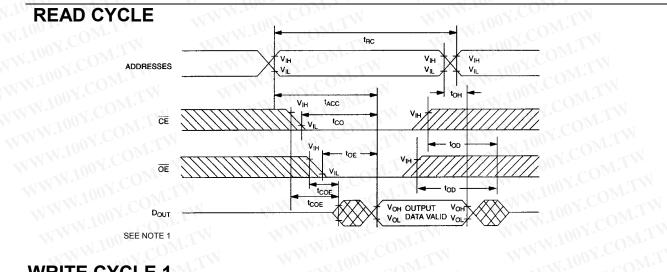
PARAMETER	SYMBOL		0AB-120 30Y-120		0AB-150 30Y-150		0AB-200 30Y-200	UNITS	NOTES
		MIN	MAX	MIN	MAX	MIN	MAX	WT	
Read Cycle Time	t _{RC}	120	100 X.CC	150	V	200	100Y.CON	ns	
Access Time	t _{ACC}	W	120	'MO	150	WW	200	ns	
OE to Output Valid	t _{OE}	N.N.	60	COM.	70	A.M.	100	ns	N.
TE to Output Valid	t _{CO}	4	120	ox.col	150	4	200	ns	W
OE or CE to Output Active	t _{COE}	5	MMM'I	5 5	DM.TW	5	WWW.100	ns	5
Output High Z from Deselection	t _{OD}	LM M	35	1.100X.0	35	47 14	35	ns	MATS
Output Hold from Address Change	t _{OH}	5	A.A.	5	NY.COM	115 1.TV	MM	ns	COM.TY
Write Cycle	t _{WC}	120	2	150	100X.CC	200	4	ns	X.COM
Write Pulse 💦 Width	t _{WP}	90	E Y	100	W.100Y.C	100	z	ns	3
Address Setup Time	t _{AW}	0	NT.N	0		.C 0		ns	100Y.CO
Write Recovery Time	t _{WR1} t _{WR2}	5 15	M.I.W	5 15	WW.10	5 15	M.TW	ns	12 13
Output High Z from \overline{WE}	t _{ODW}	100X.	35	2	35	100X.C	35	ns	N 5 00
Output Active from \overline{WE}	t _{OEW}	5	Y.COM.T	5	MMA	5	.COM.TY	ns	5
Data Setup Time	t _{DS}	50	OY.CON	60	W	80	Y.COM.I	ns	4
Data Hold Time	t _{DH1} t _{DH2}	0 10	100Y.CO	0 10	W	0 10	00Y.CO.	ns	12 13

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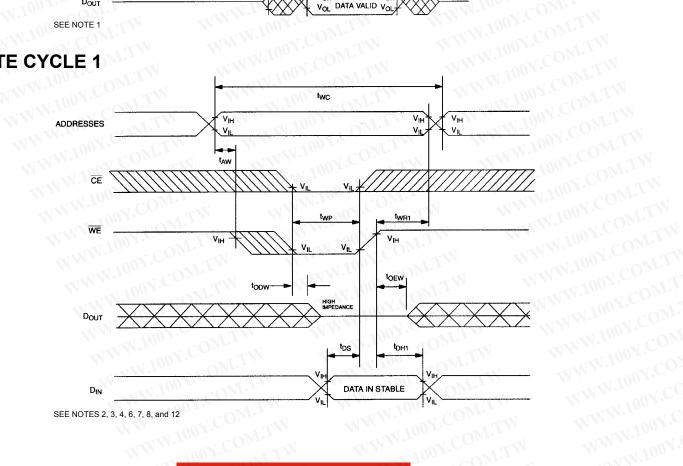
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WRITE CYCLE 1



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WRITE CYCLE 2 WWW.100Y.COM.TW twc WW.10 VIH VIH VIH ADDRESSES VIL Vii VIL taw twp twR2 CE WWW.100X.COM.TV VIH vнţ V VIL WWW.100Y.COM.TW VIH WWW.100X.COLWEI WW.100Y.COM.TW Vii WWW.100Y.COM.TW **COE** topw WWW.100Y.COM.TW D_{OUT} WWW.100Y.COM 100X.COM.TW WWW.100Y.COM.TW NITON.COM.TW tos t_{DH2} WWW.100Y.COM.TW ۷⊪ DIN DATA IN STABLE WWW.100Y.COM.TW ٧ıL 100Y.COM

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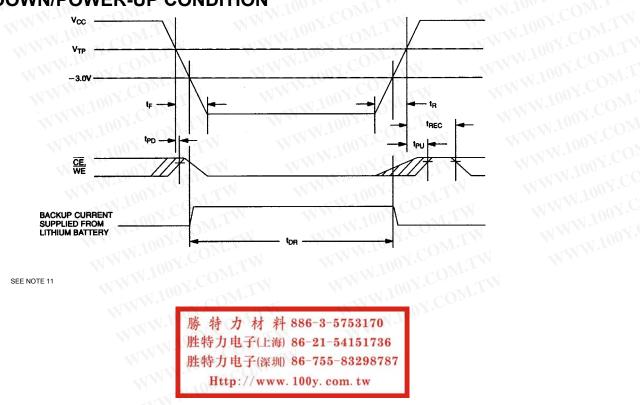
SEE NOTES 2, 3, 4, 6, 7, 8, and 13

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POWER-DOWN/POWER-UP CONDITION



POWER-DOWN/POWER-UP TIM	MING	WW	W.100Y	V.COM.I	ں (t _A : See ۱	0S1230Y/AI
PARAMETER	SYMBOL	MIN	TYP	MAX	UNITS	NOTES
V_{CC} Fail Detect to \overline{CE} and \overline{WE} Inactive	t _{PD}	<	WW.	1.5	μs	11
V _{CC} slew from V _{TP} to 0V	t _F	150	WWW.	100Y.CU	μs	
V _{CC} slew from 0V to V _{TP}	t _R	150	MMM	100Y.C	μs	
V_{CC} Valid to \overline{CE} and \overline{WE} Inactive	t _{PU}	W	MM	2	ms	
V _{CC} Valid to End of Write Protection	t _{REC}	TW	MN	125	ms	

 $(+ -25^{\circ}C)$

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PARAMETER	SYMBOL	MIN	TYP	MAX	UNITS	NOTES
Expected Data Retention Time	t _{DR}	10		WWW.	years	9

WARNING:

Under no circumstance are negative undershoots, of any amplitude, allowed when device is in battery backup mode.

NOTES:

- $\overline{\text{WE}}$ is high for a Read Cycle. 1.
- $\overline{OE} = V_{IH}$ or V_{IL} . If $\overline{OE} = V_{IH}$ during write cycle, the output buffers remain in a high-impedance state. 2.
- 3. t_{WP} is specified as the logical AND of \overline{CE} and \overline{WE} . t_{WP} is measured from the latter of \overline{CE} or \overline{WE} going low to the earlier of \overline{CE} or \overline{WE} going high.
- 4. t_{DH} , t_{DS} are measured from the earlier of \overline{CE} or \overline{WE} going high.
- 5. These parameters are sampled with a 5 pF load and are not 100% tested.
- 6. If the \overline{CE} low transition occurs simultaneously with or latter than the \overline{WE} low transition, the output buffers remain in a high-impedance state during this period.
- 7. If the \overline{CE} high transition occurs prior to or simultaneously with the \overline{WE} high transition, the output buffers remain in high-impedance state during this period.
- 8. If \overline{WE} is low or the \overline{WE} low transition occurs prior to or simultaneously with the \overline{CE} low transition, the output buffers remain in a high-impedance state during this period.
- 9. Each DS1230 has a built-in switch that disconnects the lithium source until V_{CC} is first applied by the user. The expected t_{DR} is defined as accumulative time in the absence of V_{CC} starting from the time power is first applied by the user.
- 10. All AC and DC electrical characteristics are valid over the full operating temperature range. For commercial products, this range is 0°C to 70°C. For industrial products (IND), this range is -40°C to +85°C.
- 11. In a power-down condition the voltage on any pin may not exceed the voltage on V_{CC} .
- 12. t_{WR1} and t_{DH1} are measured from \overline{WE} going high.
- 13. t_{WR2} and t_{DH2} are measured from \overline{CE} going high.
- 14. DS1230 modules are recognized by Underwriters Laboratory (U.L.®) under file E99151.



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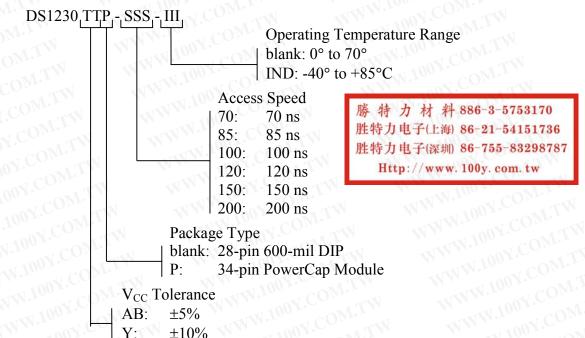
DC TEST CONDITIONS

Outputs Open Cycle = 200 ns for operating current All voltages are referenced to ground

AC TEST CONDITIONS

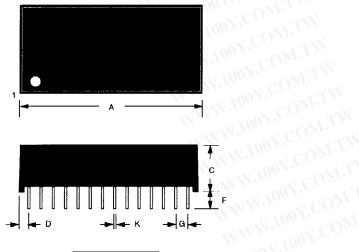
Output Load: 100 pF + 1TTL Gate Input Pulse Levels: 0 - 3.0V **Timing Measurement Reference Levels** Input: 1.5V Output: 1.5V Input pulse Rise and Fall Times: 5 ns

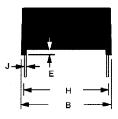
ORDERING INFORMATION



DS1230Y/AB NONVOLATILE SRAM, 28-PIN 740-MIL EXTENDED DIP MODULE

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PKG	28-	PIN
DIM	MIN	MAX
A IN.	1.480	1.500
MM	37.60	38.10
B IN.	0.720	0.740
MM	18.29	18.80
C IN.	0.355	0.375
MM	9.02	9.52
D IN.	0.080	0.110
MM	2.03	2.79
E IN.	0.015	0.025
MM	0.38	0.63
F IN.	0.120	0.160
MM	3.05	4.06
G IN.	0.090	0.110
MM	2.29	2.79
H IN.	0.590	0.630
MM	14.99	16.00
J IN.	0.008	0.012
MM	0.20	0.30
K IN.	0.015	0.021
MM	0.38	0.53

DS1230Y/AB NONVOLATILE SRAM, 34-PIN POWERCAP MODULE

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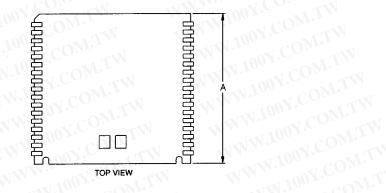
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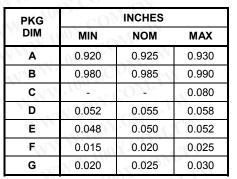
SIDE VIEW

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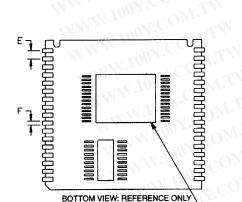
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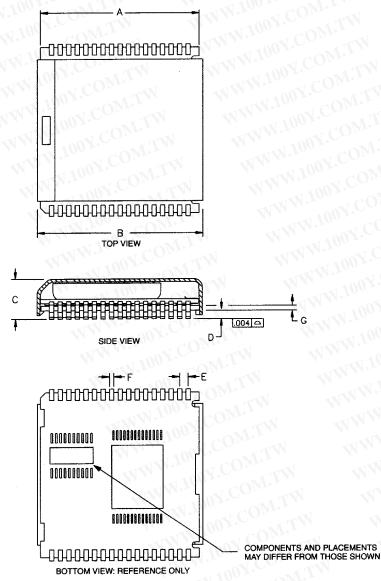


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COMPONENTS AND PLACEMENTS MAY DIFFER FROM THOSE SHOWN

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DS1230Y/AB NONVOLATILE SRAM, 34-PIN POWERCAP MODULE WITH POWERCAP



PKG	OY.CO	INCHES	
DIM	MIN	NOM	MAX
A	0.920	0.925	0.930
В	0.955	0.960	0.965
С	0.240	0.245	0.250
D	0.052	0.055	0.058
E	0.048	0.050	0.052
F	0.015	0.020	0.025
G	0.020	0.025	0.030

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ASSEMBLY AND USE

Reflow soldering

Dallas Semiconductor recommends that PowerCap Module bases experience one pass through solder reflow oriented label-side up (live-bug).

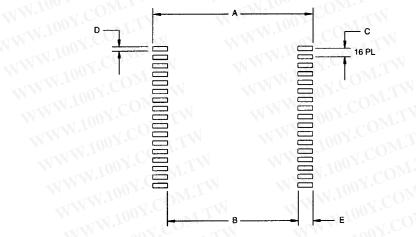
Hand soldering and touch-up

Do not touch soldering iron to leads for more than 3 seconds. To solder, apply flux to the pad, heat the lead frame pad and apply solder. To remove part, apply flux, heat pad until solder reflows, and use a solder wick.

LPM replacement in a socket

To replace a Low Profile Module in a 68-pin PLCC socket, attach a DS9034PC PowerCap to a module base then insert the complete module into the socket one row of leads at a time, pushing only on the corners of the cap. Never apply force to the center of the device. To remove from a socket, use a PLCC extraction tool and ensure that it does not hit or damage any of the module IC components. Do not use any other tool for extraction.

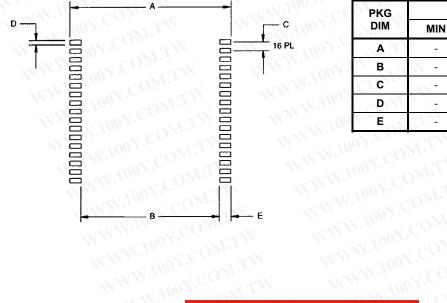
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PKG	1100X.	INCHES			
DIM	MIN	NOM	MAX		
Α	N. 7.	1.050	-N		
В	W.Ivo	0.826	-		
С	10	0.050	1.1.		
D		0.030	T		
Е	N-N-*	0.112			

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RECOMMENDED POWERCAP MODULE SOLDER STENCIL



PKG	1	INCHES		
DIM	MIN	NOM	MAX	
Α	<u> </u>	1.050	11001	
В		0.890	001	
С		0.050	N	
D		0.030	W.10	
E	TI	0.080	1	

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